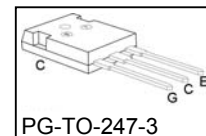
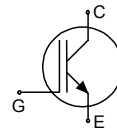


## Fast IGBT in NPT-technology

- 40% lower  $E_{off}$  compared to previous generation
- Short circuit withstand time – 10  $\mu$ s
- Designed for:
  - Motor controls
  - Inverter
  - SMPS
- NPT-Technology offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behaviour
  - parallel switching capability



- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>

| Type      | $V_{CE}$ | $I_C$ | $E_{off}$ | $T_j$ | Marking   | Package     |
|-----------|----------|-------|-----------|-------|-----------|-------------|
| SGW25N120 | 1200V    | 25A   | 2.9mJ     | 150°C | SGW25N120 | PG-TO-247-3 |

### Maximum Ratings

| Parameter                                                                                            | Symbol            | Value      | Unit             |
|------------------------------------------------------------------------------------------------------|-------------------|------------|------------------|
| Collector-emitter voltage                                                                            | $V_{CE}$          | 1200       | V                |
| DC collector current                                                                                 | $I_C$             | 46         | A                |
| $T_C = 25^\circ\text{C}$                                                                             |                   | 25         |                  |
| $T_C = 100^\circ\text{C}$                                                                            |                   | 84         |                  |
| Pulsed collector current, $t_p$ limited by $T_{jmax}$                                                | $I_{Cpuls}$       | 84         |                  |
| Turn off safe operating area                                                                         | -                 | 84         |                  |
| $V_{CE} \leq 1200\text{V}$ , $T_j \leq 150^\circ\text{C}$                                            |                   |            |                  |
| Gate-emitter voltage                                                                                 | $V_{GE}$          | $\pm 20$   | V                |
| Avalanche energy, single pulse                                                                       | $E_{AS}$          | 130        | mJ               |
| $I_C = 25\text{A}$ , $V_{CC} = 50\text{V}$ , $R_{GE} = 25\Omega$ , start at $T_j = 25^\circ\text{C}$ |                   |            |                  |
| Short circuit withstand time <sup>2</sup>                                                            | $t_{SC}$          | 10         | $\mu$ s          |
| $V_{GE} = 15\text{V}$ , $100\text{V} \leq V_{CC} \leq 1200\text{V}$ , $T_j \leq 150^\circ\text{C}$   |                   |            |                  |
| Power dissipation                                                                                    | $P_{tot}$         | 313        | W                |
| $T_C = 25^\circ\text{C}$                                                                             |                   |            |                  |
| Operating junction and storage temperature                                                           | $T_j$ , $T_{stg}$ | -55...+150 | $^\circ\text{C}$ |
| Soldering temperature, 1.6mm (0.063 in.) from case for 10s                                           | -                 | 260        |                  |

<sup>1</sup> J-STD-020 and JEDEC-022

<sup>2</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

## Thermal Resistance

| Parameter                                | Symbol     | Conditions | Max. Value | Unit |
|------------------------------------------|------------|------------|------------|------|
| <b>Characteristic</b>                    |            |            |            |      |
| IGBT thermal resistance, junction – case | $R_{thJC}$ |            | 0.4        | K/W  |
| Thermal resistance, junction – ambient   | $R_{thJA}$ |            | 40         |      |

## Electrical Characteristic, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                                         | Symbol        | Conditions                                                                                  | Value    |            |             | Unit    |
|-------------------------------------------------------------------|---------------|---------------------------------------------------------------------------------------------|----------|------------|-------------|---------|
|                                                                   |               |                                                                                             | min.     | typ.       | max.        |         |
| Static Characteristic                                             |               |                                                                                             |          |            |             |         |
| Collector-emitter breakdown voltage                               | $V_{(BR)CES}$ | $V_{GE}=0V$ ,<br>$I_C=1500\mu A$                                                            | 1200     | -          | -           | V       |
| Collector-emitter saturation voltage                              | $V_{CE(sat)}$ | $V_{GE} = 15V$ , $I_C=25A$<br>$T_j=25^{\circ}C$<br>$T_j=150^{\circ}C$                       | 2.5<br>- | 3.1<br>3.7 | 3.6<br>4.3  |         |
| Gate-emitter threshold voltage                                    | $V_{GE(th)}$  | $I_C=1000\mu A$ ,<br>$V_{CE}=V_{GE}$                                                        | 3        | 4          | 5           |         |
| Zero gate voltage collector current                               | $I_{CES}$     | $V_{CE}=1200V, V_{GE}=0V$<br>$T_j=25^{\circ}C$<br>$T_j=150^{\circ}C$                        | -<br>-   | -<br>-     | 350<br>1400 | $\mu A$ |
| Gate-emitter leakage current                                      | $I_{GES}$     | $V_{CE}=0V, V_{GE}=20V$                                                                     | -        | -          | 100         | nA      |
| Transconductance                                                  | $g_{fs}$      | $V_{CE}=20V, I_C=25A$                                                                       |          | 20         | -           | S       |
| Dynamic Characteristic                                            |               |                                                                                             |          |            |             |         |
| Input capacitance                                                 | $C_{iss}$     | $V_{CE}=25V$ ,                                                                              | -        | 2150       | 2600        | pF      |
| Output capacitance                                                | $C_{oss}$     | $V_{GE}=0V$ ,                                                                               | -        | 160        | 190         |         |
| Reverse transfer capacitance                                      | $C_{rss}$     | $f=1MHz$                                                                                    | -        | 110        | 130         |         |
| Gate charge                                                       | $Q_{Gate}$    | $V_{CC}=960V, I_C=25A$<br>$V_{GE}=15V$                                                      | -        | 225        | 300         | nC      |
| Internal emitter inductance<br>measured 5mm (0.197 in.) from case | $L_E$         |                                                                                             | -        | 13         | -           | nH      |
| Short circuit collector current <sup>1)</sup>                     | $I_{C(SC)}$   | $V_{GE}=15V, t_{SC}\leq 10\mu s$<br>$100V\leq V_{CC}\leq 1200V$ ,<br>$T_j\leq 150^{\circ}C$ | -        | 240        | -           | A       |

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

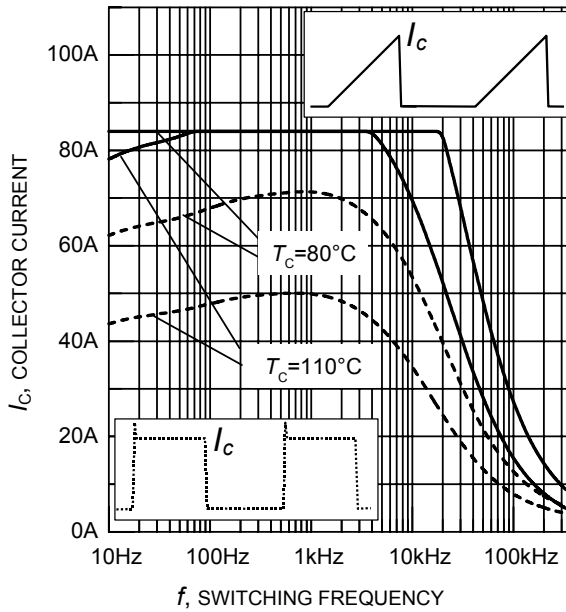
## Switching Characteristic, Inductive Load, at $T_j=25^\circ\text{C}$

| Parameter              | Symbol       | Conditions                                                                                                                                                                                          | Value                                                |      |      | Unit |     |
|------------------------|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------|------|------|------|-----|
|                        |              |                                                                                                                                                                                                     | min.                                                 | typ. | max. |      |     |
| IGBT Characteristic    |              |                                                                                                                                                                                                     |                                                      |      |      |      |     |
| Turn-on delay time     | $t_{d(on)}$  | $T_j=25^{\circ}\text{C}$ ,<br>$V_{CC}=800\text{V}$ , $I_C=25\text{A}$ ,<br>$V_{GE}=15\text{V}/0\text{V}$ ,<br>$R_G=22\Omega$ ,<br>$L_{\sigma}^{1)}=180\text{nH}$ ,<br>$C_{\sigma}^{1)}=40\text{pF}$ | -                                                    | 45   | 60   | ns   |     |
| Rise time              | $t_r$        |                                                                                                                                                                                                     | $V_{CC}=800\text{V}$ , $I_C=25\text{A}$ ,            | -    | 40   |      | 52  |
| Turn-off delay time    | $t_{d(off)}$ |                                                                                                                                                                                                     | $V_{GE}=15\text{V}/0\text{V}$ ,                      | -    | 730  |      | 950 |
| Fall time              | $t_f$        |                                                                                                                                                                                                     | $R_G=22\Omega$ ,<br>$L_{\sigma}^{1)}=180\text{nH}$ , | -    | 30   |      | 39  |
| Turn-on energy         | $E_{on}$     | Energy losses include<br>“tail” and diode<br>reverse recovery.                                                                                                                                      | -                                                    | 2.2  | 2.9  | mJ   |     |
| Turn-off energy        | $E_{off}$    |                                                                                                                                                                                                     | -                                                    | 1.5  | 2.0  |      |     |
| Total switching energy | $E_{ts}$     |                                                                                                                                                                                                     | -                                                    | 3.7  | 4.9  |      |     |

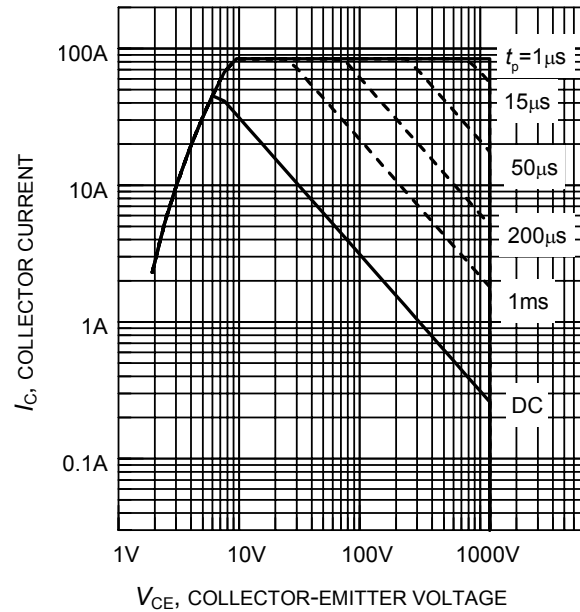
## Switching Characteristic, Inductive Load, at $T_j=150^\circ\text{C}$

| Parameter              | Symbol       | Conditions                                                                                                                                                                                            | Value |      |      | Unit |
|------------------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
|                        |              |                                                                                                                                                                                                       | min.  | typ. | max. |      |
| IGBT Characteristic    |              |                                                                                                                                                                                                       |       |      |      |      |
| Turn-on delay time     | $t_{d(on)}$  | $T_j=150^{\circ}\text{C}$<br>$V_{CC}=800\text{V}$ ,<br>$I_C=25\text{A}$ ,<br>$V_{GE}=15\text{V}/0\text{V}$ ,<br>$R_G=22\Omega$ ,<br>$L_{\sigma}^{1)}=180\text{nH}$ ,<br>$C_{\sigma}^{1)}=40\text{pF}$ | -     | 50   | 60   | ns   |
| Rise time              | $t_r$        |                                                                                                                                                                                                       | -     | 36   | 43   |      |
| Turn-off delay time    | $t_{d(off)}$ |                                                                                                                                                                                                       | -     | 820  | 990  |      |
| Fall time              | $t_f$        |                                                                                                                                                                                                       | -     | 42   | 50   |      |
| Turn-on energy         | $E_{on}$     | Energy losses include<br>“tail” and diode<br>reverse recovery.                                                                                                                                        | -     | 3.8  | 4.6  | mJ   |
| Turn-off energy        | $E_{off}$    |                                                                                                                                                                                                       | -     | 2.9  | 3.8  |      |
| Total switching energy | $E_{ts}$     |                                                                                                                                                                                                       | -     | 6.7  | 8.4  |      |

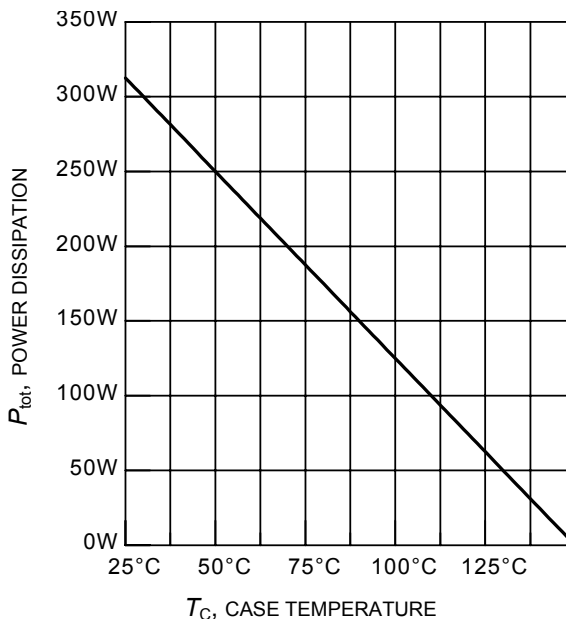
<sup>1)</sup> Leakage inductance  $L_{\sigma}$  and stray capacity  $C_{\sigma}$  due to dynamic test circuit in figure E.



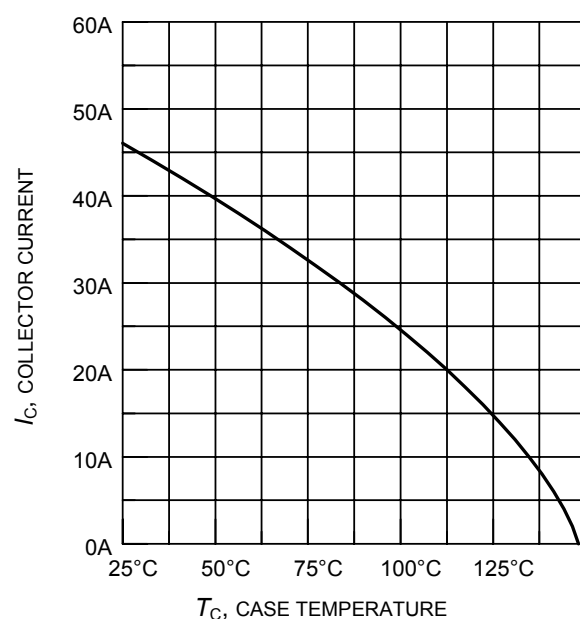
**Figure 1. Collector current as a function of switching frequency**  
 $(T_j \leq 150^\circ\text{C}, D = 0.5, V_{CE} = 800\text{V}, V_{GE} = +15\text{V}/0\text{V}, R_G = 22\Omega)$



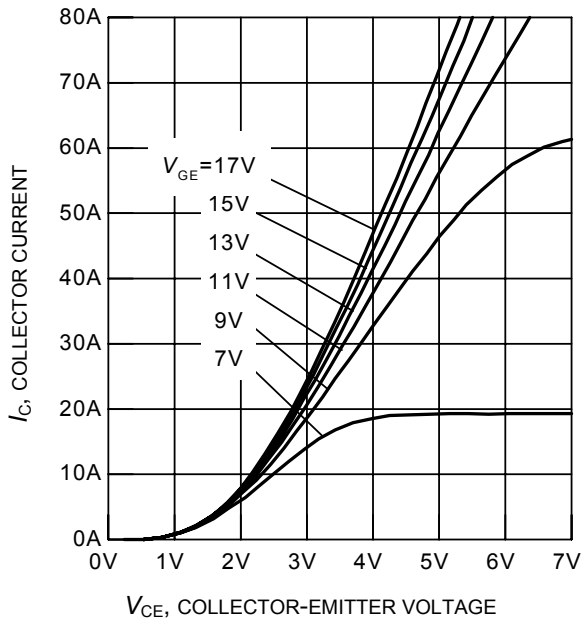
**Figure 2. Safe operating area**  
 $(D = 0, T_C = 25^\circ\text{C}, T_j \leq 150^\circ\text{C})$



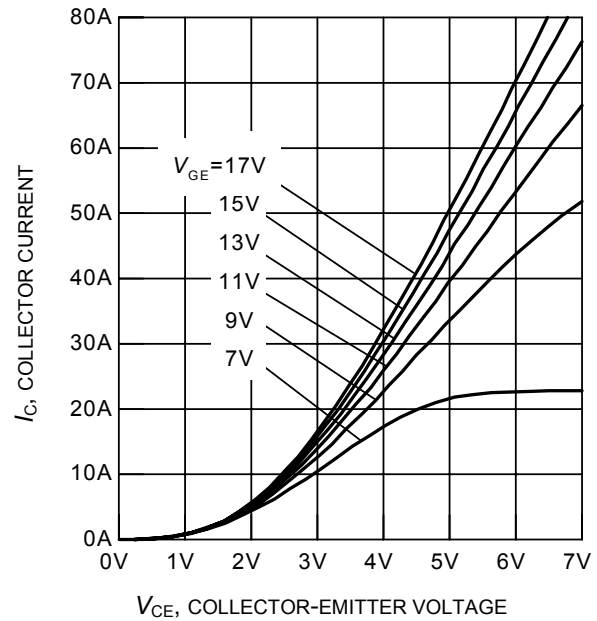
**Figure 3. Power dissipation as a function of case temperature**  
 $(T_j \leq 150^\circ\text{C})$



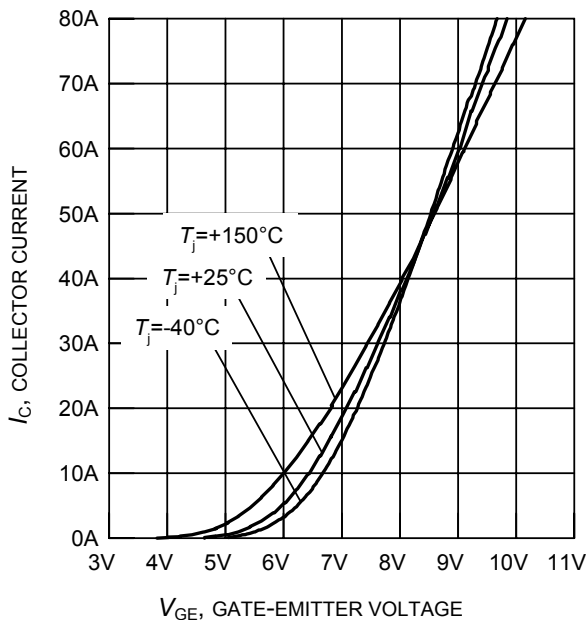
**Figure 4. Collector current as a function of case temperature**  
 $(V_{GE} \leq 15\text{V}, T_j \leq 150^\circ\text{C})$



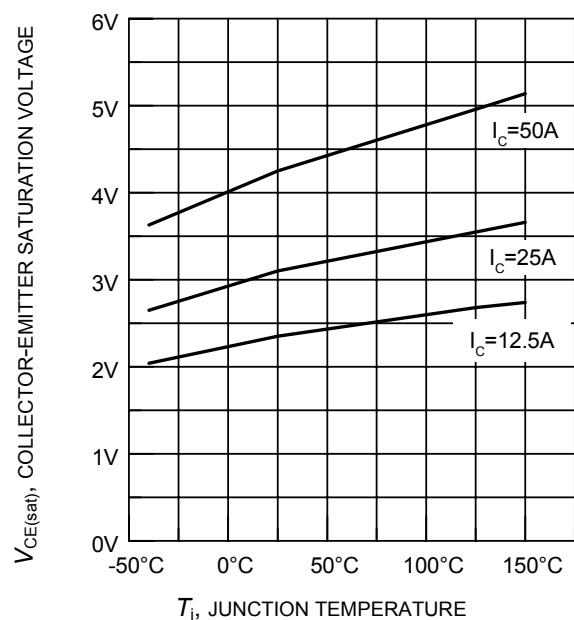
**Figure 5. Typical output characteristics**  
( $T_j = 25^\circ\text{C}$ )



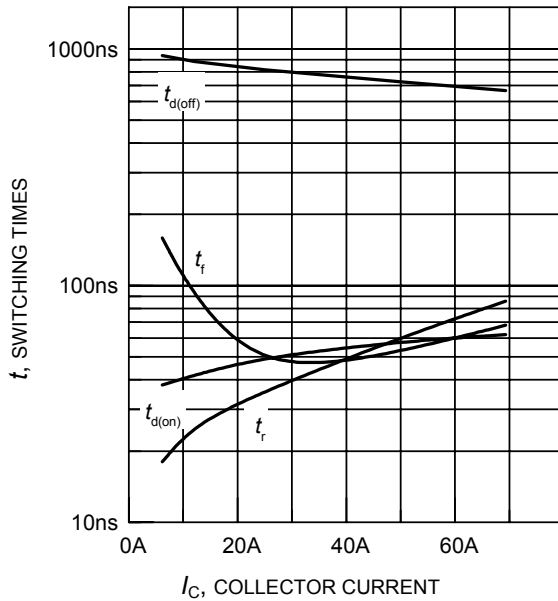
**Figure 6. Typical output characteristics**  
( $T_j = 150^\circ\text{C}$ )



**Figure 7. Typical transfer characteristics**  
( $V_{CE} = 20V$ )

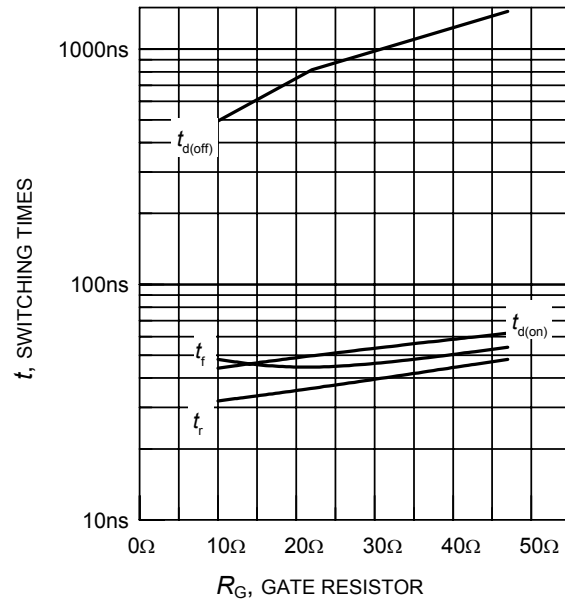


**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15V$ )



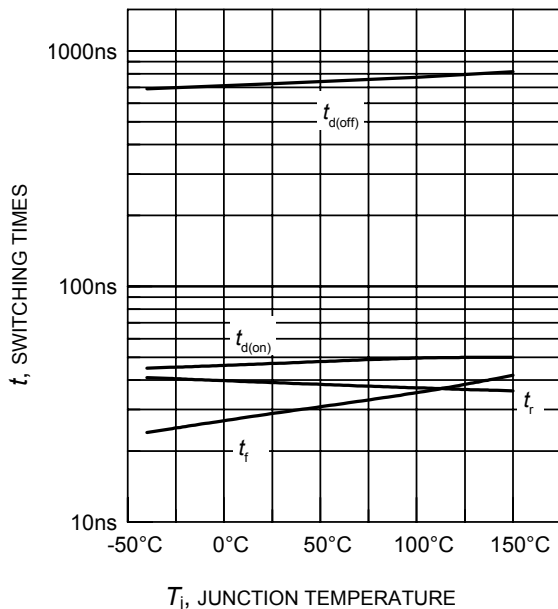
**Figure 9. Typical switching times as a function of collector current**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  
 $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 22\Omega$ ,  
dynamic test circuit in Fig.E )



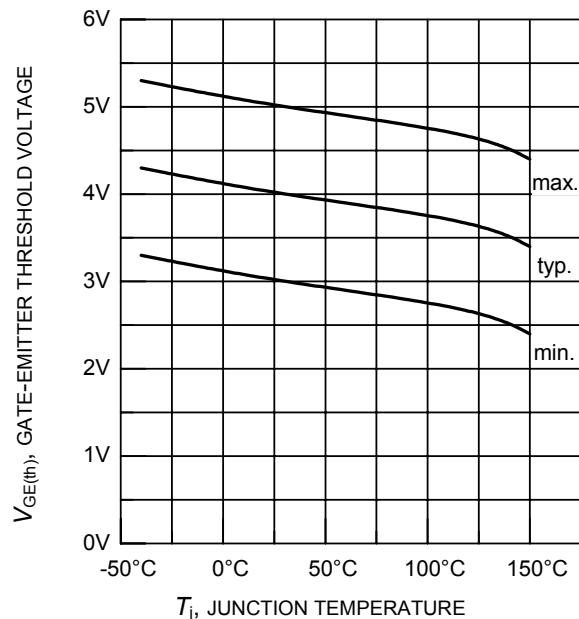
**Figure 10. Typical switching times as a function of gate resistor**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  
 $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 25\text{A}$ ,  
dynamic test circuit in Fig.E )



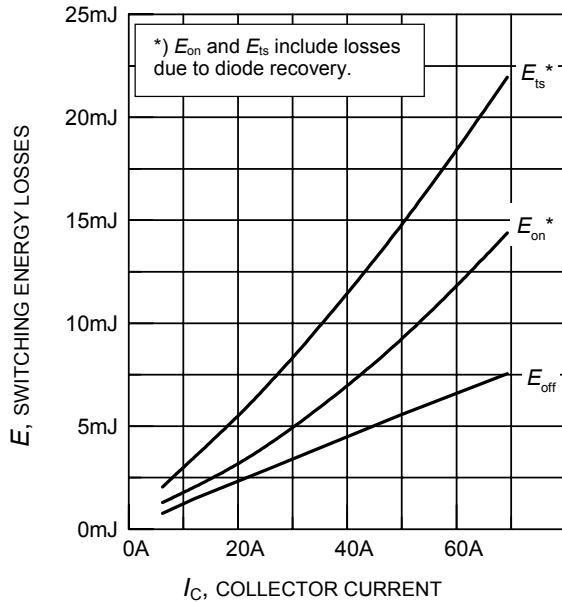
**Figure 11. Typical switching times as a function of junction temperature**

(inductive load,  $V_{CE} = 800\text{V}$ ,  
 $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 25\text{A}$ ,  $R_G = 22\Omega$ ,  
dynamic test circuit in Fig.E )



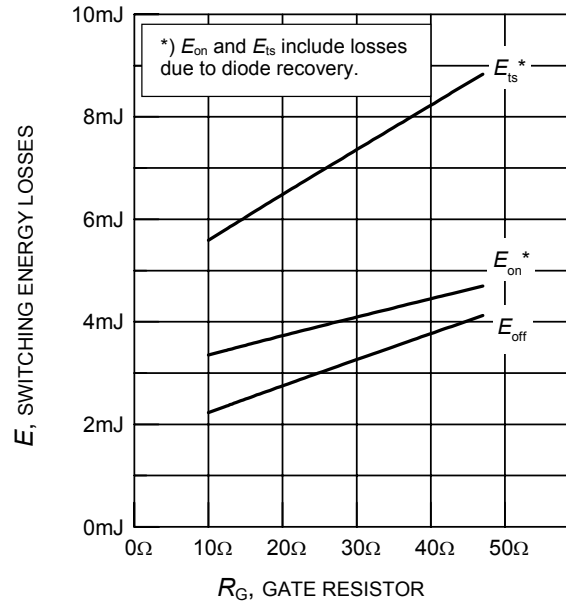
**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**

( $I_C = 0.3\text{mA}$ )



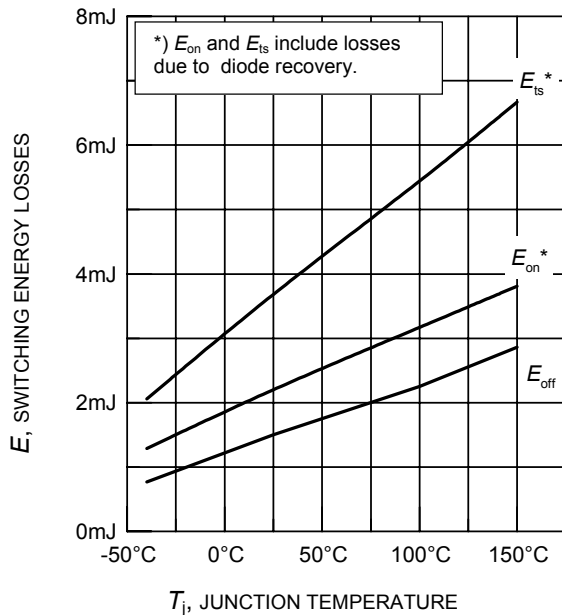
**Figure 13. Typical switching energy losses as a function of collector current**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 22\Omega$ , dynamic test circuit in Fig.E )



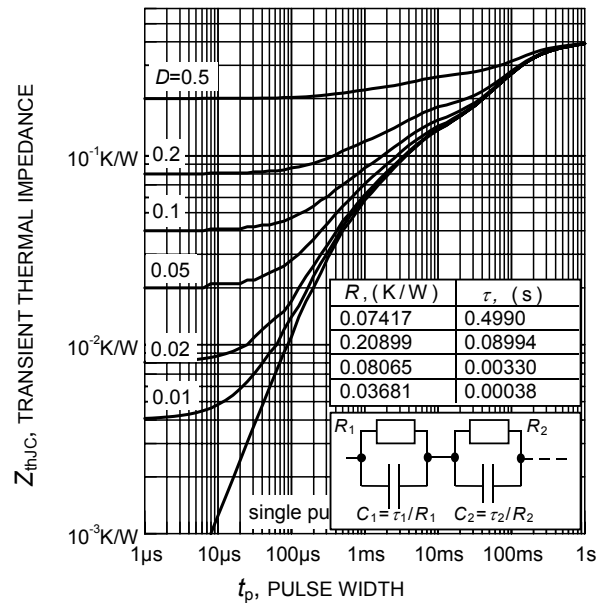
**Figure 14. Typical switching energy losses as a function of gate resistor**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 25\text{A}$ , dynamic test circuit in Fig.E )

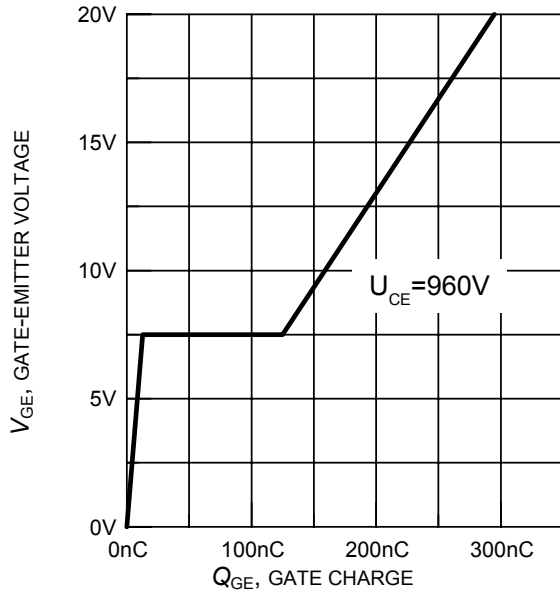


**Figure 15. Typical switching energy losses as a function of junction temperature**

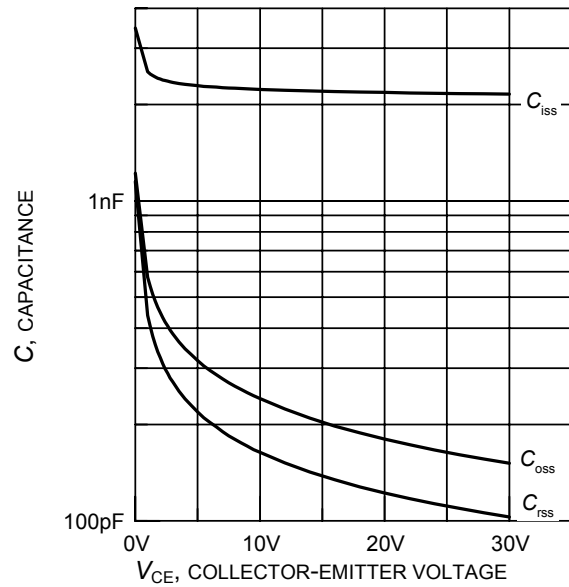
(inductive load,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 25\text{A}$ ,  $R_G = 22\Omega$ , dynamic test circuit in Fig.E )



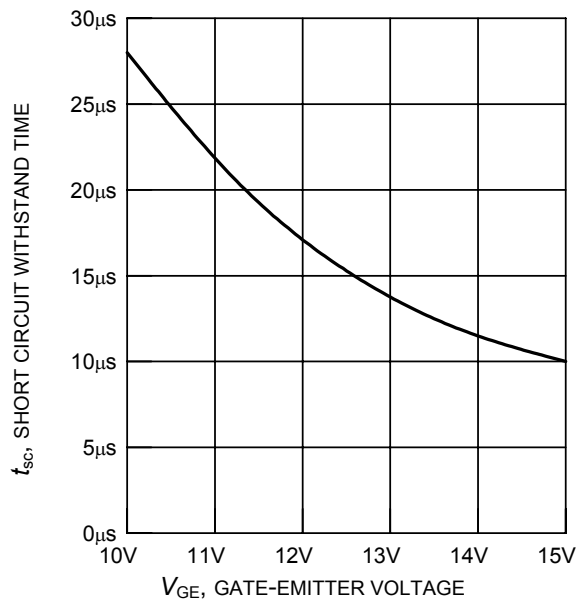
**Figure 16. IGBT transient thermal impedance as a function of pulse width**  
( $D = t_p / T$ )



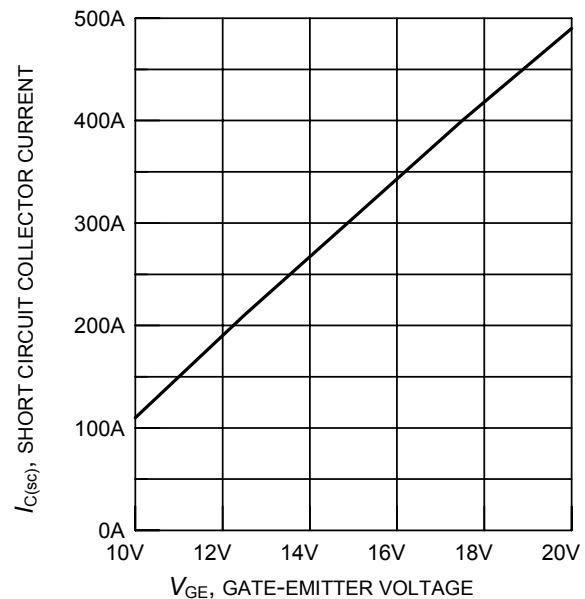
**Figure 17. Typical gate charge**  
( $I_C = 25A$ )



**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE} = 0V$ ,  $f = 1MHz$ )



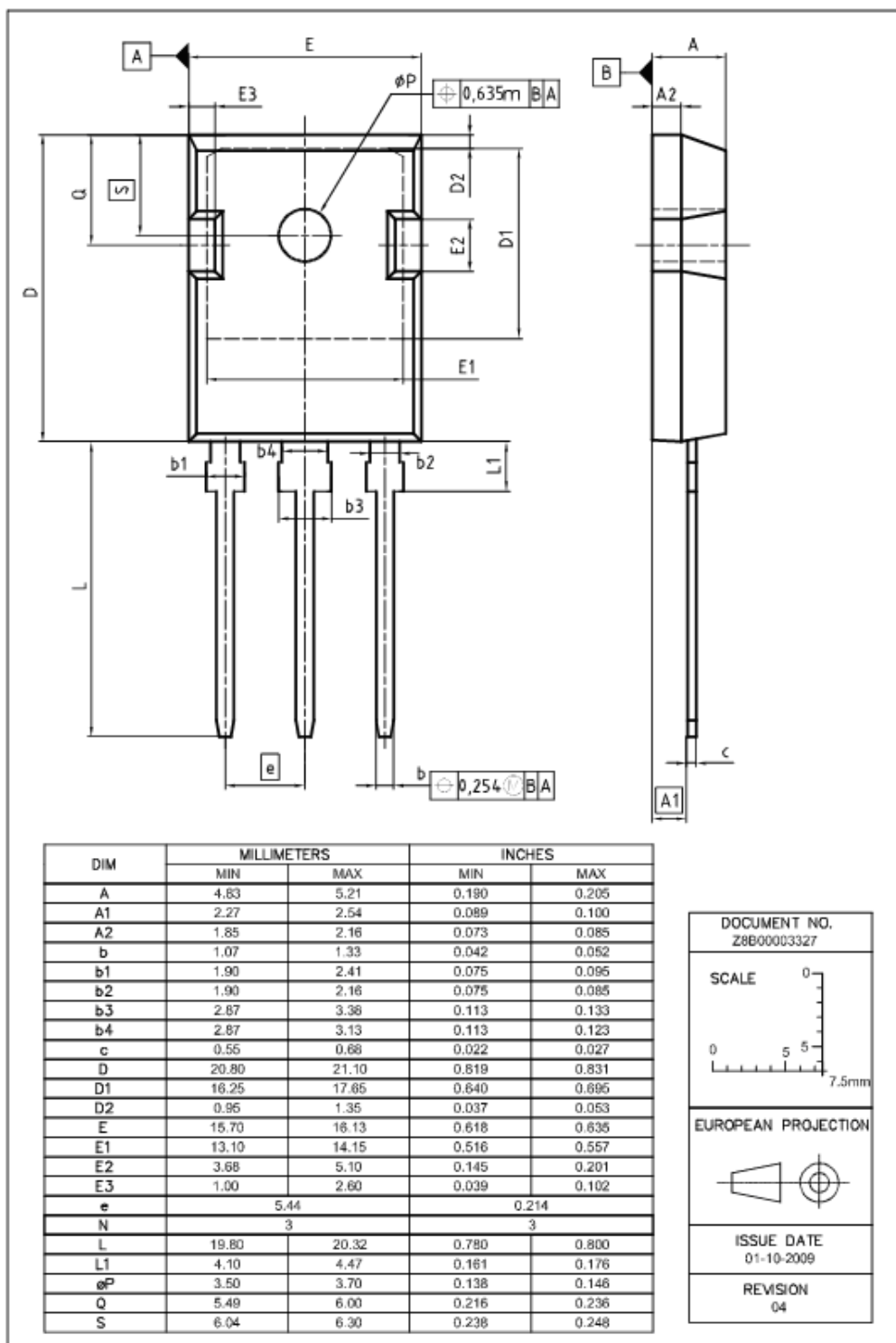
**Figure 19. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE} = 1200V$ , start at  $T_j = 25^\circ C$ )

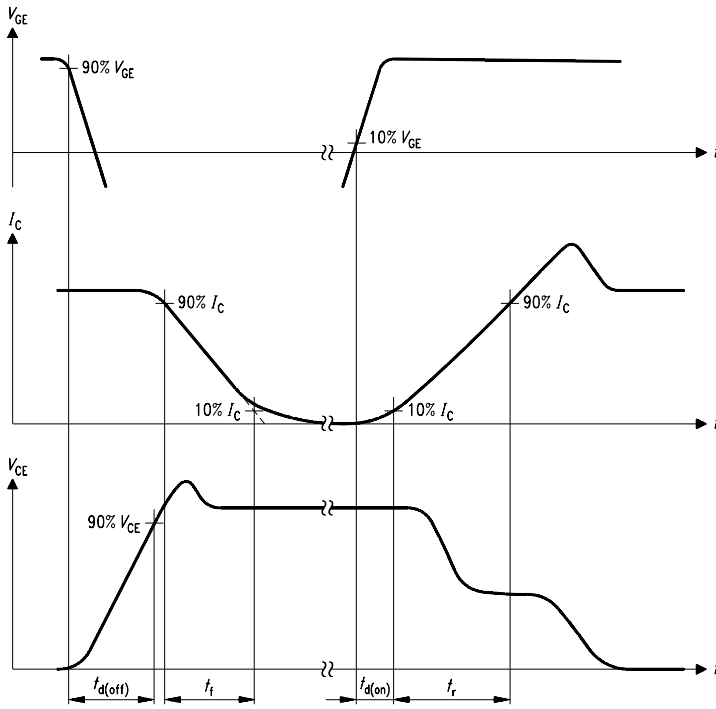


**Figure 20. Typical short circuit collector current as a function of gate-emitter voltage**  
( $100V \leq V_{CE} \leq 1200V$ ,  $T_C = 25^\circ C$ ,  $T_j \leq 150^\circ C$ )

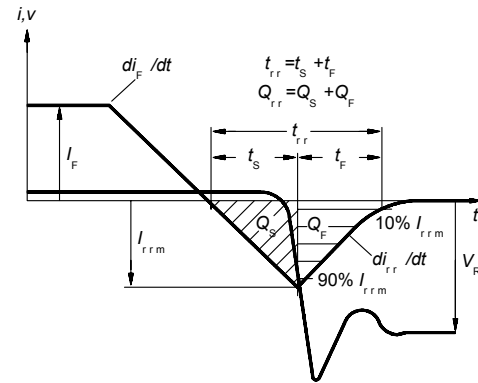
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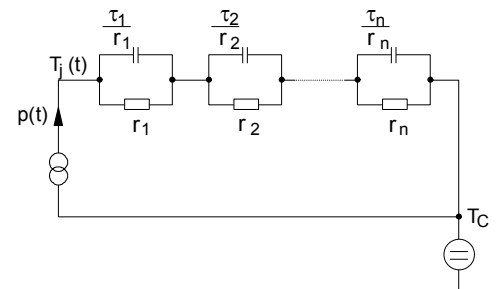




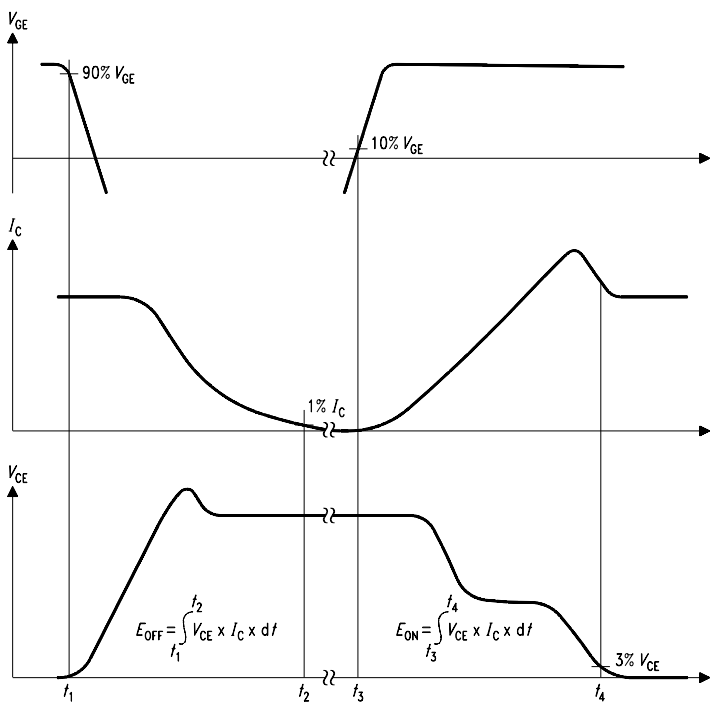
**Figure A. Definition of switching times**



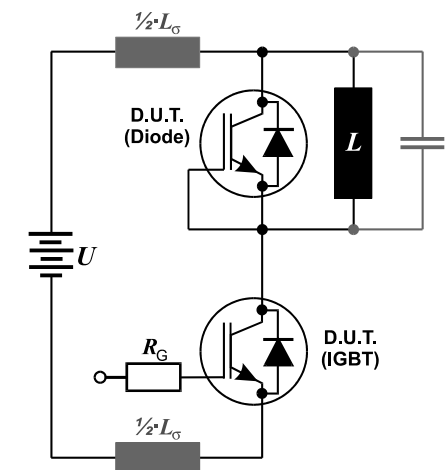
**Figure C. Definition of diodes switching characteristics**



**Figure D. Thermal equivalent circuit**



**Figure B. Definition of switching losses**



**Figure E. Dynamic test circuit**  
Leakage inductance  $L_\sigma = 180\text{nH}$ ,  
and stray capacity  $C_\sigma = 40\text{pF}$ .

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